

# **TDF8597**

I<sup>2</sup>C-bus controlled dual channel 43 W/2 Ω, single channel 85 W/1 Ω class-D power amplifier with full diagnostics

Rev. 1 — 17 November 2011

Preliminary short data sheet

## 1. General description

The TDF8597 is a dual Bridge-Tied Load (BTL) car audio amplifier comprising an NDMOST-NDMOST output stage based on SOI BCDMOS technology. The TDF8597 fully supports start/stop systems as it can operate at a battery voltage as low as 6 V. The TDF8597 can be controlled with or without I<sup>2</sup>C. I<sup>2</sup>C allows control of load detection results and fault conditions to be read. The TDF8597 is a high efficiency class-D amplifier with low dissipation. Due to the low dissipation, the device can be used with a smaller heat sink than standard class AB amplifiers. Six different I<sup>2</sup>C addresses can be selected with external resistors connected to the ADS and MOD pins. If pin ADS is a short-circuit to ground, the TDF8597 operates in non-I<sup>2</sup>C mode, and no I<sup>2</sup>C communication is possible. Use pins EN and ON to switch to operating and mute modes.

## 2. Features and benefits

- High-efficiency
- Low quiescent current
- Operating voltage from 6 V to 24 V
- Start/Stop ready: continues to operate without audible disturbance during engine start at a battery voltage as low as 6 V
- 4  $\Omega$  or 2  $\Omega$  capable stereo BTL channels or 1  $\Omega$  capable mono BTL channel
- Differential inputs
- Fast-mode I<sup>2</sup>C-bus
- I<sup>2</sup>C-bus mode with 6 I<sup>2</sup>C-bus addresses or non-I<sup>2</sup>C-bus mode operation
- Clip detect selectable at 0.2 % or 10 % THD
- Independent short-circuit protection for each channel
- Advanced short-circuit protection for load, GND and supply
- Thermal foldback and thermal protection
- DC-offset protection
- Selectable AD or BD modulation
- Advanced clocking:
  - Switchable oscillator clock source: internal for Master mode or external for Slave mode
  - Spread spectrum mode
  - Phase staggering
  - Frequency hopping
- No 'pop noise' caused by DC output offset voltage
- I<sup>2</sup>C-bus mode:



#### I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

Load diagnostics

Speaker load, open load and shorted load Amplifier output to ground and to supply shorts Tweeter detection

- Thermal pre-warning diagnostic level setting
- Identification of activated protection or warnings
- Selectable diagnostic information available on DIAG and CLIP pins
- Qualified in accordance with AEC-Q100

#### **Quick reference data** 3.

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
General; V <sub>P</sub> = 14.4 V						
VP	supply voltage		6	14.4	24	V
I <sub>P</sub>	supply current	off state; V <sub>EN</sub> < 0.8 V	-	2	10	μΑ
lq	quiescent current	no load, snubbers and output filter connected	-	90	120	mA
Stereo mode; V <sub>P</sub> = 14.4 V						
Po	output power	$R_L = 4 \Omega$ ; THD = 10 %	24	26	-	W
		$R_L = 2 \Omega$ ; THD = 10 %	39	43	-	W
Stereo mode; V <sub>P</sub> = 24 V						
Po	output power	$R_L = 4 \Omega$ ; THD = 10 %	-	70	-	W
		$R_L = 2 \Omega$ ; THD = 10 %	-	100	-	W
Parallel mode; V <sub>P</sub> = 14.4 V						
Po	output power	R <sub>L</sub> = 1 Ω; THD = 10 %	-	85	-	W
Parallel mode; V <sub>P</sub> = 24 V						
Po	output power	$R_L = 2 \Omega$ ; THD = 10 %	-	138	-	W
		$R_L = 1 \Omega$ ; THD = 1 %	135	150	-	W

#### **Ordering information** 4.

#### Table 2. **Ordering information**

Type number	Package					
	Name	Description	Version			
TDF8597TH	HSOP36	HSOP36: plastic, heatsink small outline package; 36 leads; low stand-off height	SOT851-2			

# **TDF8597**

#### I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

## 5. Block diagram



### **NXP Semiconductors**

# **TDF8597**

I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

# 6. Limiting values

#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
VP	supply voltage	Operating mode		-	29	V
		off state	[1]	-1	+50	V
		load dump; duration 50 ms; t <sub>r</sub> > 2.5 ms		-	50	V
I <sub>ORM</sub>	repetitive peak output current	maximum output current limiting	[2]	8	-	А
I <sub>OM</sub>	peak output current	non-repetitive:				
		Stereo mode		-	18	А
		Parallel mode		-	12	А
I <sub>sink(max)</sub>	maximum sink current	pins DIAG and CLIP		0	5	mA
V <sub>i</sub>	input voltage	referred to GNDD:				
		pins SCL and SDA		0	5.5	V
		pins DIAG and CLIP		0	10	V
		pin OSCIO		0	5.5	V
		referred to AGND:				
		pins EN and ON		0	5.5	V
		pins ADS, MOD and SSM		0	5.5	V
		pins IN1P, IN1N, IN2P, and IN2N		0	10	V
V <sub>i(dif)</sub>	differential input voltage	RMS; pins IN1P, IN1N, IN2P, and IN2N		0	3	V
R <sub>ESR</sub>	equivalent series resistance	as seen between pins $V_P$ and <code>PGNDn</code>		-	350	mΩ
Tj	junction temperature			-	150	°C
T <sub>stg</sub>	storage temperature			-55	+150	°C
T <sub>amb</sub>	ambient temperature			-40	+85	°C
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ	[3]			
		C = 100 pF; $R_s$ = 1.5 k $\Omega$		-	2000	V
		CDM	[4]			
		non-corner pins (except pin 10, V <sub>DDA</sub> )		-	500	V
		pin 10, V <sub>DDA</sub>		-	300	V
		corner pins		-	750	V
V <sub>(prot)</sub>	protection voltage	AC and DC short-circuit voltage of output pins across load and to supply and ground	<u>[5]</u>	0	V <sub>P</sub>	V

[1] Floating condition assumed for outputs.

[2] Current limiting concept.

[3] Human Body Model (HBM).

[4] Charged-Device Model (CDM).

[5] The output pins are defined as the output pins of the filter connected between the TDF8597 output pins and the load.

TDF8597\_SDS

Preliminary short data sheet

### I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

# 7. Revision history

Table 4. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
TDF8597_SDS v.1	20111117	Preliminary short data sheet	-	-

## 8. Legal information

#### 8.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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TDF8597\_SDS

Preliminary short data sheet

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# TDF8597

#### I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

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# **TDF8597**

I<sup>2</sup>C-bus controlled single and dual channel class-D amplifier

## **10. Contents**

1	General description 1
2	Features and benefits 1
3	Quick reference data 2
4	Ordering information 2
5	Block diagram 3
6	Limiting values 4
7	Revision history 5
8	Legal information 6
8.1	Data sheet status 6
8.2	Definitions6
8.3	Disclaimers 6
8.4	Trademarks
9	Contact information 7
10	Contents 8

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